LDMOS 2-stage integrated Doherty MMIC Rev. 1 — 13 October 2020

Product profile 1.

1.1 General description

The BLM9D1819-08AM is a 2-stage 8 W fully integrated Doherty MMIC solution using Ampleon's state of the art GEN9 LDMOS technology. The carrier and peaking device, input splitter and output combiner are integrated in a single package. This multiband device is perfectly suited as a device in the frequency range from 1805 MHz to 1880 MHz. Available in LGA outline.

Table 1. Performance

Typical RF performance at $T_{case} = 25 \ C$; $I_{Dq} = 23 \ mA$ (driver and final stages) in a demo circuit; $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55 V.$

Test signal	f	V _{DS}	P _{L(AV)}	G _p	η _D	
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
single carrier W-CDMA [1]	1842.5	28	1.12	27.7	44	-30

[1] Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

1.2 Features and benefits

- Integrated input splitter
- Integrated output combiner
- Very high efficiency
- Designed for broadband operation (frequency 1805 MHz to 1880 MHz)
- Independent control of carrier and peaking bias
- Integrated ESD protection
- Excellent thermal stability
- High power gain, input and output matched to impedance 50 Ω
- For RoHS compliance see the product details on the Ampleon website

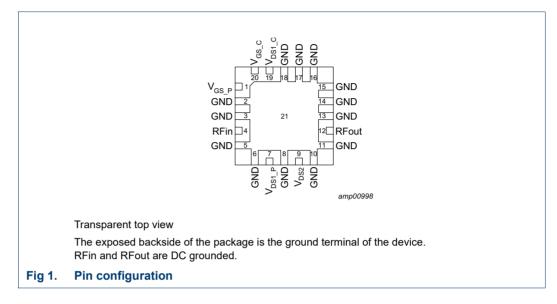
1.3 Applications

RF power MMIC for multi-carrier and multi-standard GSM, W-CDMA, LTE and NR small cell base stations in the 1805 MHz to 1880 MHz frequency range

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2. Pinning information

2.1 Pinning



2.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
V _{GS_P}	1	gate-source voltage of peaking
GND	2	ground
GND	3	ground
RFin	4	RF input
GND	5	ground
GND	6	ground
V _{DS1_P}	7	drain-source voltage of peaking driver
GND	8	ground
V _{DS2}	9	drain-source voltage of final stages
GND	10	ground
GND	11	ground
RFout	12	RF output
GND	13	ground
GND	14	ground
GND	15	ground
GND	16	ground
GND	17	ground
GND	18	ground

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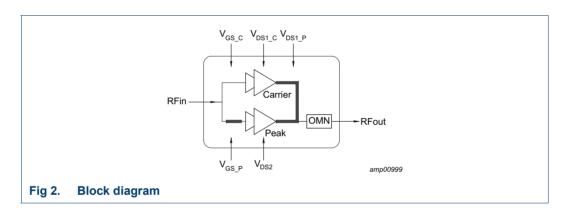
Table 2. Pin descriptioncontinued				
Symbol Pin		Pin	Description	
V _{DS1_C}		19	drain-source voltage of carrier driver	
V _{GS_C}		20	gate-source voltage of carrier driver	
GND 21		21	RF ground	

3. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
BLM9D1819-08AM		plastic thermal enhanced package; no leads; 20 terminals; body 7.0 x 7.0 x 0.98 mm	LGA-7x7-20-1				

4. Block diagram



5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage		-	65	V
V _{GS}	gate-source voltage		-6	+11	V
T _{stg}	storage temperature		-55	+125	°C
Tj	junction temperature	[1]	-	175	°C
T _{case}	case temperature	[1]	-	125	°C

[1] Continuous use at maximum temperature will affect the reliability. For details refer to the online MTF calculator.

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6. Thermal characteristics

Table 5. Thermal characteristics

Measured for total device.

Symbol	Parameter	Conditions	Value	Unit
R _{th(j-c)}	thermal resistance from junction to	$T_{case} = 80 \ ^{\circ}C; P_{L(AV)} = 1.12 \ W$ [1]	9.2	K/W
	case	$T_{case} = 80 \ ^{\circ}C; P_{L(AV)} = 1.78 \ W$ [1]	8.3	K/W

[1] When operated with a 1-carrier W-CDMA with PAR = 7.2 dB.

7. Characteristics

Table 6. DC characteristics

 T_{case} = 25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
Carrier	1	1						
V _{GSq}	gate-source quiescent voltage	V _{DS} = 28 V; I _D = 23 mA	1.65	2.03	2.75	V		
I _{GSS}	gate leakage current	V_{GS} = 11 V/–5 V; V_{DS} = 0 V	-	-	140	nA		
Peaking								
I _{GSS}	gate leakage current	V_{GS} = 11 V/–5 V; V_{DS} = 0 V	-	-	140	nA		
Final stages								
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 60 V	-	-	1.4	μA		
Driver stages								
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 60 V	-	-	1.4	μA		

Table 7. RF Characteristics

Typical RF performance at $T_{case} = 25 \ ^{\circ}C$; $V_{DS} = 28 \ V$; $I_{Dq} = 23 \ mA$ (carrier); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55 \ V$; $P_L = 1.12 \ W$; $f = 1.88 \ GHz$. Unless otherwise specified, measured in an Ampleon production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
Test signal: CW pulsed								
G _p	power gain		25.5	27.5	30	dB		
η _D	drain efficiency		37	43.5	-	%		
RL _{in}	input return loss		-	-16	-11	dB		
P _{L(3dB)}	output power at 3 dB gain compression		38.5	39.6	-	dBm		

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8. Application information

Table 8. Typical performance

Test signal: 1-carrier W-CDMA; $T_{case} = 25 \, ^{\circ}C$; $V_{DS} = 28 \, V$; $I_{Dq} = 23 \, mA$ (driver and final stages); test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability CCDF; unless otherwise specified, measured in an Ampleon 1805 MHz to 1880 MHz frequency band demo circuit.

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
P _{L(3dB)}	output power at 3 dB gain compression	f = 1842.5 MHz	[1]	-	40	-	dBm
η _D	drain efficiency	P _{L(AV)} = 30.5 dBm; f = 1805 MHz		-	44	-	%
G _p	power gain	P _{L(AV)} = 30.5 dBm; f = 1805 MHz		-	27.7	-	dB
G _{flat}	gain flatness	P _{L(AV)} = 30.5 dBm; f = 1805 MHz to 1880 MHz		-	0.8	-	dB
ACPR _{5M}	adjacent channel power ratio (5 MHz)	P _{L(AV)} = 30.5 dBm; f = 1805 MHz		-	-30	-	dBc
$\Delta G / \Delta T$	gain variation with temperature	f = 1805 MHz		-	0.04	-	dB/∘C
К	Rollett stability factor	T _{case} = –40 °C; f = 0.15 GHz to 5 GHz	[2]	-	>1	-	

[1] Pulsed CW power sweep measurement (δ = 10 %, t_p = 100 µs).

[2] S-parameters measured in a demo circuit.

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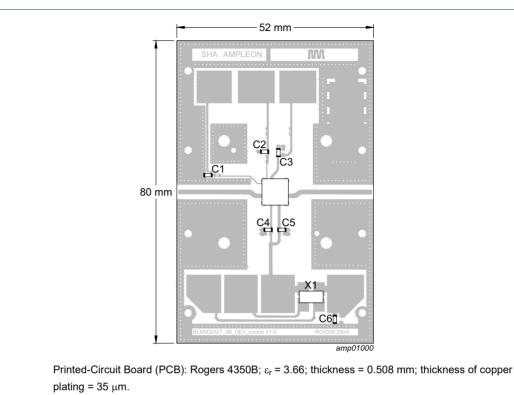


Fig 3. Component layout

Table 9. Demo test circuit list of components

See Figure 3 for component layout.

Component	Description	Value	Remarks
C1, C2, C3, C4, C5	multilayer ceramic chip capacitor	1μF [1]	
C6	multilayer ceramic chip capacitor	1μF [2]	
X1	current sense resistor	100 mΩ, 1 W	Y44870R10000B0R

[1] American Technical Ceramics type 600F or capacitor of same quality.

[2] Murata or capacitor of same quality.

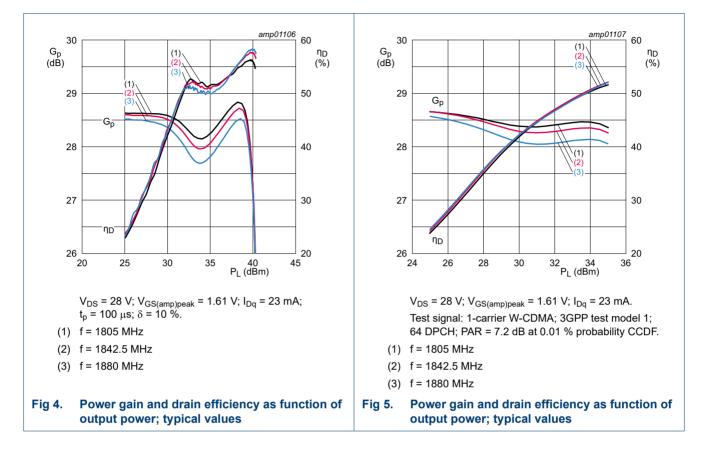
8.1 Ruggedness in a Doherty operation

The BLM9D1819-08AM is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 28 V; I_{Dq} = 23 mA (carrier); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55$ V; P_i corresponding to $P_{L(3dB)}$ under Z_S = 50 Ω load; f = 1805 MHz (CW); T_{case} = 25 °C.

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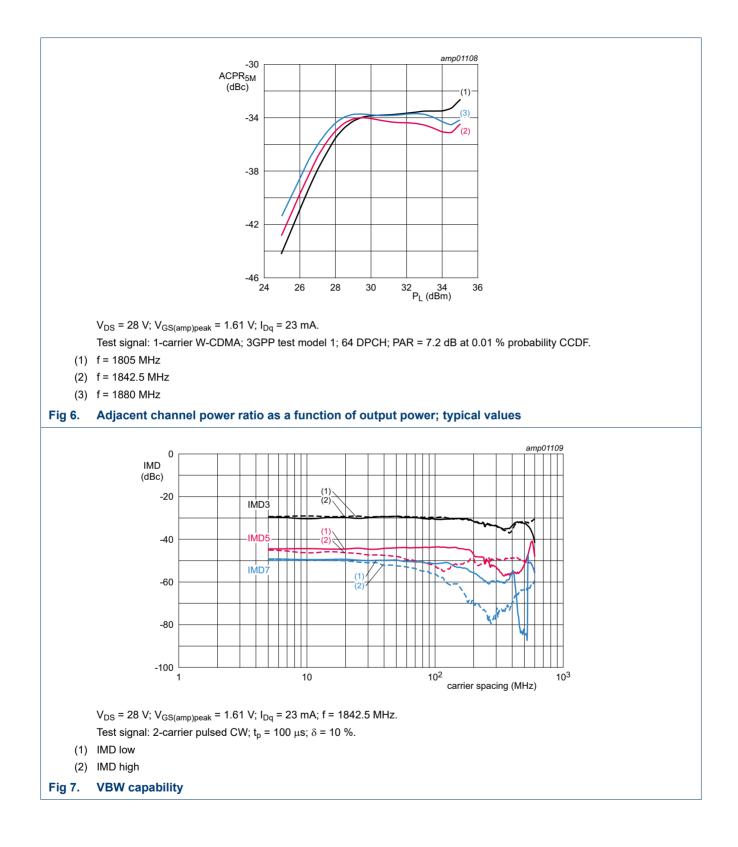


8.2 Graphs

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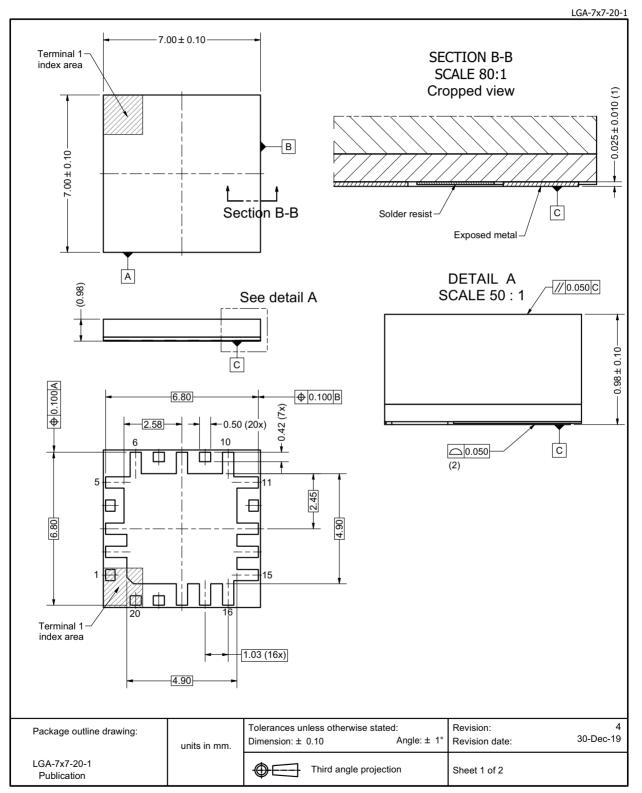
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9. Package outline





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LGA-7x7-20-1

		Dra	awing Notes		
	Iten	n	Description		
	1	M	etal thickness of solder pads.		
	2	Flatne	ss with respect to exposed metal		
Package outline drawing:		Tolerances ur	less otherwise stated:	Revision:	4
r achage outilite urawilig.	units in mm.	Dimension: ±		Revision date:	30-Dec-19
LGA-7x7-20-1					
			Third angle projection	Sheet 2 of 2	

Fig 9. Package outline LGA-7x7-20-1 (sheet 2 of 2)

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10. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 10. ESD sensitivity

ESD model	Class			
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002				
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1C 🛛			

[1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V.

[2] HBM classification 1C is granted to any part that passes after exposure to an ESD pulse of 1000 V.

11. Abbreviations

Table 11. Abbreviations				
Acronym	Description			
3GPP	3rd Generation Partnership Project			
CCDF	Complementary Cumulative Distribution Function			
CW	Continuous Wave			
DPCH	Dedicated Physical CHannel			
ESD	ElectroStatic Discharge			
GEN9	Ninth Generation			
GSM	Global System for Mobile Communications			
LDMOS	Laterally Diffused Metal Oxide Semiconductor			
LTE	Long Term Evolution			
MMIC	Monolithic Microwave Integrated Circuit			
MTF	Median Time to Failure			
NR	New Radio			
PAR	Peak-to-Average Ratio			
RoHS	Restriction of Hazardous Substances			
VBW	Video BandWidth			
VSWR	Voltage Standing Wave Ratio			
W-CDMA	Wideband Code Division Multiple Access			

12. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLM9D1819-08AM v.1	20201013	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 13 October 2020 Document identifier: BLM9D1819-08AM